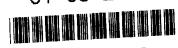
FORM :PTO-1595 (Modified) (Rev. 6-93)
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ocket No.: TSL1583

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

		<u> </u>
To the Honorable Commissioner of Patents and Trademarks		
<ol> <li>Name of conveying party(ies):         Hiroji Enami         Masayuki Onishi         Tadashi Okawa         Masaaki Amako</li> </ol>	2. Name and address of receiving Name: Dow Corning Toray S  Address: 4th Floor, AIG Bui	Silicone Company, UTD
Additional names(s) of conveying party(ies)	Marunouchi, Chiyod-ku	7026
3. Nature of conveyance:		
☐ Security Agreement ☐ Change of Name	City: <u>Tokyo 100-0005</u>	State/Prov.:
Other	Country: Japan	ZIP:
Execution Date: October 17, 2000	Additional name(s) & address(es)	☐ Yes ☒ No
4. Application number(s) or registration numbers(s): If this document is being filed together with a new application Patent Application No. Filing date	on, the execution date of the applica  B. Patent No.(s)	tion is: October 17, 2000
Additional numbers  5. Name and address of party to whom correspondence concerning document should be mailed:	s Yes 🗷 No  6. Total number of applications	and patents involved: 1
<ol><li>Name and address of party to whom correspondence concerning document should be mailed:</li></ol>	6. Total number of applications  7. Total fee (37 CFR 3.41):	\$ 40.00
5. Name and address of party to whom correspondence concerning document should be mailed:  Name: Larry A. Milco  Registration No. 41,196	6. Total number of applications  7. Total fee (37 CFR 3.41):  Enclosed - Any excess of credited or debited to de	\$ 40.00 or insufficiency should be posit account
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## ASSIGNMENT

WHEREAS We, Hiroji Enami; Masayuki Onishi; Tadashi Okawa; and Masaaki Amako have invented certain new and useful improvements in

## for which application for United States Letters Patent has been executed by us on the 17th day of October \_\_\_\_\_\_\_, 2000; and,

THERMALLY CONDUCTIVE SILICONE RUBBER COMPOSITION

WHEREAS, DOW CORNING TORAY SILICONE COMPANY, LTD., of 4th Floor, AIG Building, 1-1-3, Marunouchi, Chiyoda-ku, Tokyo 100-0005, Japan, is desirous of acquiring the said invention and said application and any and all Letters Patent that may be obtained therefor or thereupon, and all reissues and extensions thereof;

HEREBY AUTHORIZE and request the Commissioner of Patents and Trademarks to issue the said Letters Patent and any reissues and extensions thereof to the said DOW CORNING TORAY SILICONE COMPANY, LTD. as assigns of the entire right, title and interest in and to the said invention and said application and Letters Patent issued therefore or thereupon; and

HEREBY AGREE to execute all instruments and documents within our power which may be necessary for the carrying out of this assignment in full; and to execute any divisional or continuing application or applications which may be necessary or proper to obtain full protection on the invention hereby assigned; and to execute any and all supplemental oaths and preliminary statements should the same be proper and necessary in the prosecution of the aforesaid applications; and

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HEREBY FURTHER ASSIGN unto the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors, and assigns, the whole right, title and interest in and to the invention disclosed in the said application throughout all countries foreign to the United States, and do hereby ratify any acts of the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns, in applying for patents therefore in its own name in countries where such procedure is proper and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors, and to execute assignments of such applications and the patents to be obtained therefore to the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns.

IN WITNESS WHEREOF I have hereunto set my hand	
Hiroji Enami Hiroji Enami	
Hiroji Enami	
Dated: <u>Oct. 17th</u> , 2000	
This is to certify that Hiroji Enami has signed this document in my presence this	day
Signature of Witness Hiromi Fujita	
IN WITNESS WHEREOF I have hereunto set my hand	
Masayuki Onishi  Dated: Oct 17.2000	
This is to certify that Masayuki Onishi has signed this document in my presence this, and of	17th
Signature of Witness Hiromi Fujita	
IIII I I III I I III I I I I I I I I I	

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## IN WITNESS WHEREOF I have hereunto set my hand

Taderh Uhany	
Tadashi Okawa	
Dated: <u>Pelohis 17, 2000</u>	
This is to certify that Tadashi Okawa has signed this document in my presence this, 2000, Japan	
Zoromi Fujeta	
Signature of Witness Hiromi Fujita	
IN WITNESS WHEREOF I have hereunto set my hand	
Masaaki Amako  Masaaki Amako	
Dated: Derober 17, 2000	
This is to certify that Masaaki Amako has signed this document in my presence this 17th day of October, 2000, Japan.	
Valvomi Fysia	
Signature of Witness	

Hiromi Fujita

**RECORDED: 11/01/2000** 

PATENT REEL: 011388 FRAME: 0018